# BUK753R8-80E

## N-channel TrenchMOS standard level FET

11 September 2012 Product data sheet

## 1. Product profile

### 1.1 General description

Standard level N-channel MOSFET in a SOT78 package using TrenchMOS technology. This product has been designed and qualified to AEC Q101 standard for use in high performance automotive applications.

### 1.2 Features and benefits

- AEC Q101 compliant
- Repetitive avalanche rated
- Suitable for thermally demanding environments due to 175 °C rating
- True standard level gate with VGS(th) rating of greater than 1V at 175 °C

### 1.3 Applications

- 12V, 24V and 48V Automotive systems
- Electric and electro-hydraulic power steering
- Motors, lamps and solenoid control
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

### 1.4 Quick reference data

**Table 1. Quick reference data**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j \geq 25$ °C; $T_j \leq 175$ °C | | - | - | 80 | V |
| $I_D$ | drain current | $V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; Fig. 1 | [1] | - | - | 120 | A |
| $P_{tot}$ | total power dissipation | $T_{mb}$ = 25 °C; Fig. 2 | | - | - | 349 | W |
| **Static characteristics** | | | | | | | |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = 10 V; $I_D$ = 25 A; $T_j$ = 25 °C; Fig. 11 | | - | 3.3 | 4 | mΩ |
| **Dynamic characteristics** | | | | | | | |
| $Q_{GD}$ | gate-drain charge | $V_{GS}$ = 10 V; $I_D$ = 25 A; $V_{DS}$ = 64 V; Fig. 13; Fig. 14 | | - | 51 | - | nC |

[1] Continuous current is limited by package.

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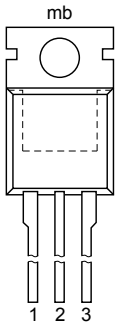
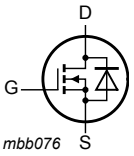
## 2. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|---|---|---|---|---|
| 1 | G | gate |   TO-220AB (SOT78A) |   |
| 2 | D | drain | | |
| 3 | S | source | | |
| mb | D | mounting base; connected to drain | | |

## 3. Ordering information

**Table 3. Ordering information**

| Type number | Package | | |
|---|---|---|---|
| | Name | Description | Version |
| BUK753R8-80E | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78A |

## 4. Marking

**Table 4. Marking codes**

| Type number | Marking code |
|---|---|
| BUK753R8-80E | BUK753R8-80E |

## 5. Limiting values

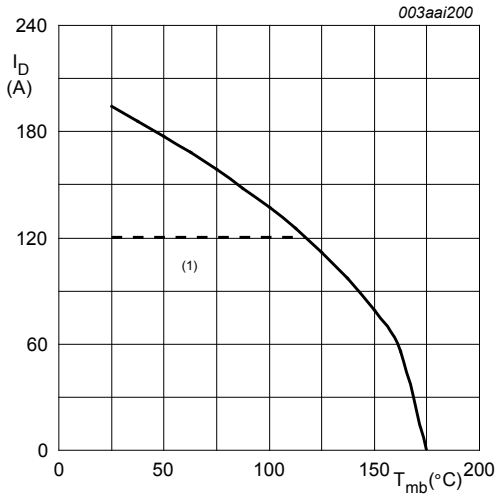
**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j \geq 25$ °C; $T_j \leq 175$ °C | | - | 80 | V |
| $V_{DGR}$ | drain-gate voltage | $R_{GS}$ = 20 kΩ | | - | 80 | V |
| $V_{GS}$ | gate-source voltage | $T_j$ = 175 °C; DC | | -20 | 20 | V |
| $I_D$ | drain current | $T_{mb}$ = 25 °C; $V_{GS}$ = 10 V; Fig. 1 | [1] | - | 120 | A |
| | | $T_{mb}$ = 100 °C; $V_{GS}$ = 10 V; Fig. 1 | [1] | - | 120 | A |
| $I_{DM}$ | peak drain current | $T_{mb}$ = 25 °C; pulsed; $t_p \leq 10$ µs; Fig. 4 | | - | 758 | A |

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---|---|---|---|---|---|---|
| $P_{tot}$ | total power dissipation | $T_{mb}$ = 25 °C; Fig. 2 | | - | 349 | W |
| $T_{stg}$ | storage temperature | | | -55 | 175 | °C |
| $T_j$ | junction temperature | | | -55 | 175 | °C |
| **Source-drain diode** | | | | | | |
| $I_S$ | source current | $T_{mb}$ = 25 °C | [1] | - | 120 | A |
| $I_{SM}$ | peak source current | pulsed; $t_p \leq 10$ µs; $T_{mb}$ = 25 °C | | - | 758 | A |
| **Avalanche ruggedness** | | | | | | |
| $E_{DS(AL)S}$ | non-repetitive drain-source avalanche energy | $I_D$ = 120 A; $V_{sup} \leq 80$ V; $R_{GS}$ = 50 Ω; $V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; unclamped; Fig. 3 | [2][3] | - | 488 | mJ |

[1] Continuous current is limited by package.
[2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.
[3] Refer to application note AN10273 for further information.




(1) Capped at 120A due to package

**Fig. 1. Continuous drain current as a function of mounting base temperature**

$$V_{GS} \geq 10V$$

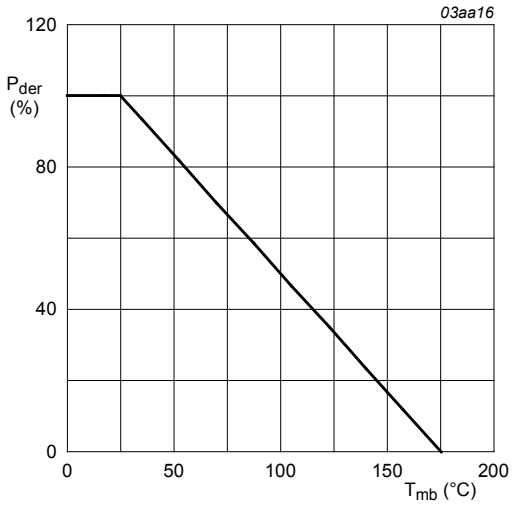



**Fig. 2. Normalized total power dissipation as a function of mounting base temperature**

$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\,\%$$

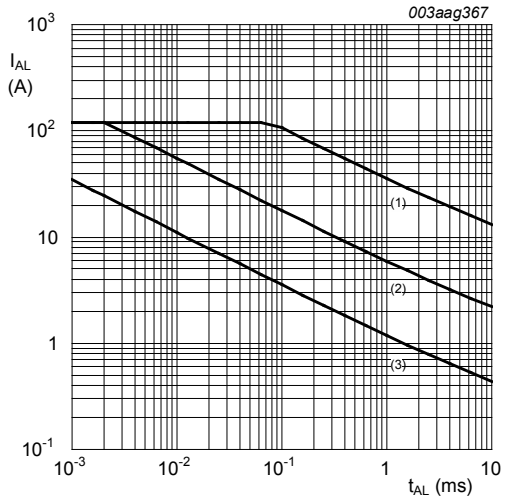



**Fig. 3. Avalanche rating; avalanche current as a function of avalanche time.**

(1) $T_{j\ (init)} = 25°C$; (2) $T_{j\ (init)} = 150°C$; (3) Repetitive Avalanche

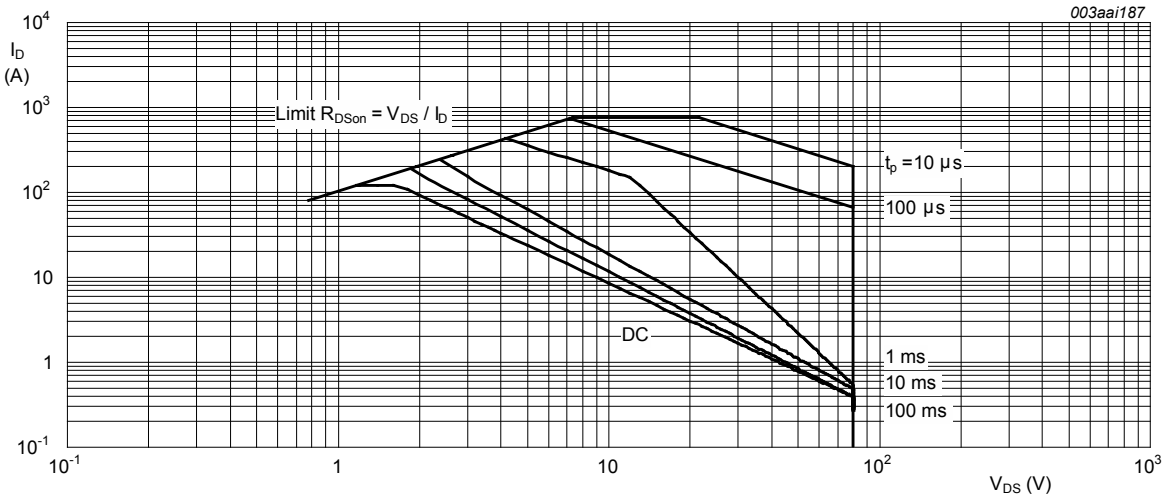



**Fig. 4. Safe operating area; continuous and peak drain currents as a function of drain-source voltage**

$T_{mb} = 25°C$; $I_{DM}$ is a single pulse

# 6. Thermal characteristics

**Table 6. Thermal characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $R_{th(j\text{-}mb)}$ | thermal resistance from junction to mounting base | Fig. 5 | | - | - | 0.43 | K/W |
| $R_{th(j\text{-}a)}$ | thermal resistance from junction to ambient | vertical in still air | | - | 60 | - | K/W |

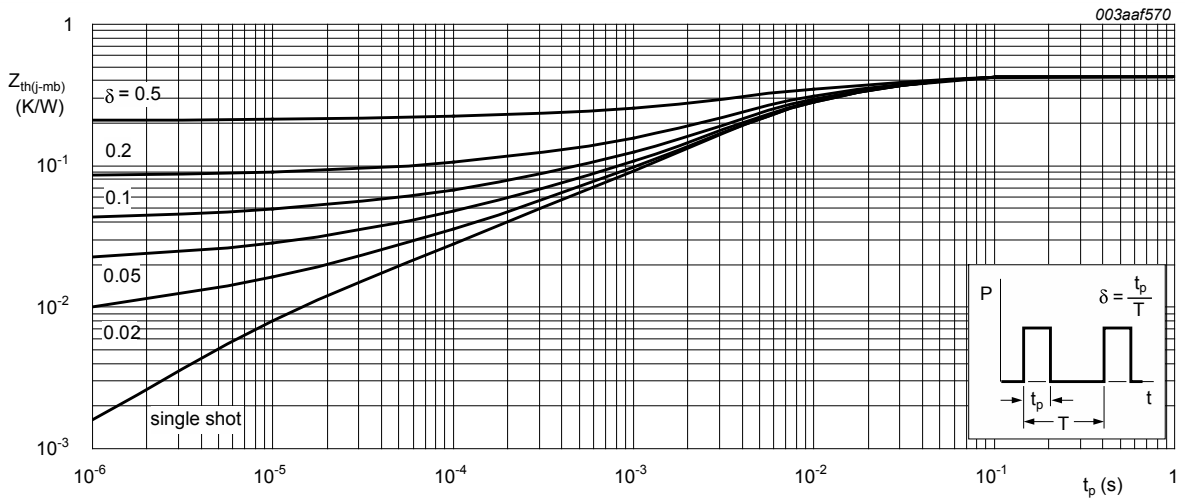


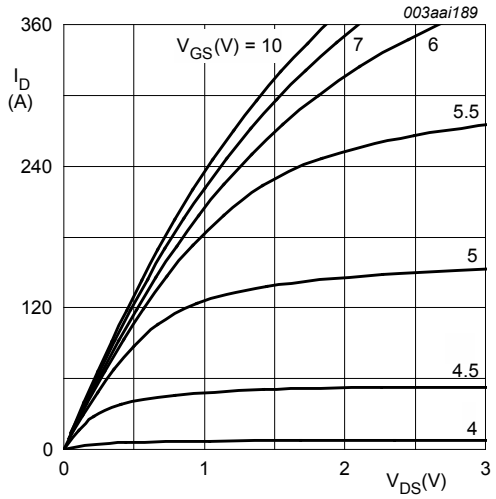

**Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration.**

# 7. Characteristics

**Table 7. Characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **Static characteristics** | | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | 80 | - | - | V |
| | | $I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = -55 °C | | 72 | - | - | V |
| $V_{GS(th)}$ | gate-source threshold voltage | $I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$; $T_j$ = 25 °C; Fig. 9; Fig. 10 | | 2.4 | 3 | 4 | V |
| | | $I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$; $T_j$ = 175 °C; Fig. 9 | | 1 | - | - | V |
| | | $I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$; $T_j$ = -55 °C; Fig. 9 | | - | - | 4.5 | V |
| $I_{DSS}$ | drain leakage current | $V_{DS}$ = 80 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | 0.15 | 2 | µA |
| | | $V_{DS}$ = 80 V; $V_{GS}$ = 0 V; $T_j$ = 175 °C | | - | - | 500 | µA |
| $I_{GSS}$ | gate leakage current | $V_{GS}$ = 20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | 2 | 100 | nA |
| | | $V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | 2 | 100 | nA |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = 10 V; $I_D$ = 25 A; $T_j$ = 25 °C; Fig. 11 | | - | 3.3 | 4 | mΩ |
| | | $V_{GS}$ = 10 V; $I_D$ = 25 A; $T_j$ = 175 °C; Fig. 12; Fig. 11 | | - | - | 9.7 | mΩ |
| **Dynamic characteristics** | | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $I_D$ = 25 A; $V_{DS}$ = 64 V; $V_{GS}$ = 10 V; Fig. 13; Fig. 14 | | - | 169 | - | nC |
| $Q_{GS}$ | gate-source charge | | | - | 37 | - | nC |
| $Q_{GD}$ | gate-drain charge | | | - | 51 | - | nC |

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $C_{iss}$ | input capacitance | $V_{GS}$ = 0 V; $V_{DS}$ = 25 V; f = 1 MHz; $T_j$ = 25 °C; Fig. 15 | | - | 9020 | 12030 | pF |
| $C_{oss}$ | output capacitance | | | - | 840 | 1010 | pF |
| $C_{rss}$ | reverse transfer capacitance | | | - | 470 | 645 | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS}$ = 60 V; $R_L$ = 2.4 Ω; $V_{GS}$ = 10 V; $R_{G(ext)}$ = 5 Ω | | - | 38 | - | ns |
| $t_r$ | rise time | | | - | 48 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | | - | 129 | - | ns |
| $t_f$ | fall time | | | - | 65 | - | ns |
| $L_D$ | internal drain inductance | from drain lead 6mm from package to centre of die | | - | 4.5 | - | nH |
| | | from upper edge of mounting base to centre of die | | - | 2.5 | - | nH |
| $L_S$ | internal source inductance | from source lead to source bond pad | | - | 7.5 | - | nH |
| **Source-drain diode** | | | | | | | |
| $V_{SD}$ | source-drain voltage | $I_S$ = 25 A; $V_{GS}$ = 0 V; $T_j$ = 25 °C; Fig. 16 | | - | 0.77 | 1.2 | V |
| $t_{rr}$ | reverse recovery time | $I_S$ = 20 A; $dI_S/dt$ = -100 A/µs; $V_{GS}$ = 0 V; $V_{DS}$ = 25 V | | - | 58 | - | ns |
| $Q_r$ | recovered charge | | | - | 121 | - | nC |




$T_j$ = 25 °C; $t_p$ = 300 µs

**Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values**

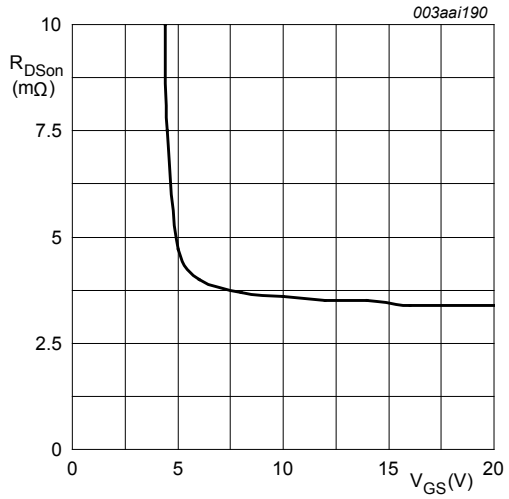



**Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values**

$T_j = 25°C;\ I_D = 25A$

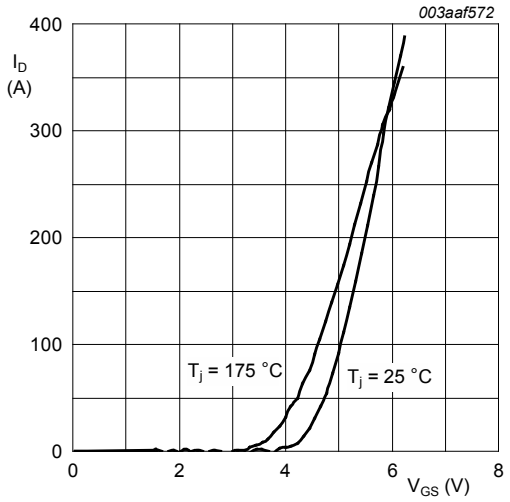



**Fig. 8. Transfer characteristics: drain current as a function of gate-source voltage; typical values**

$V_{DS} = 12\,V$

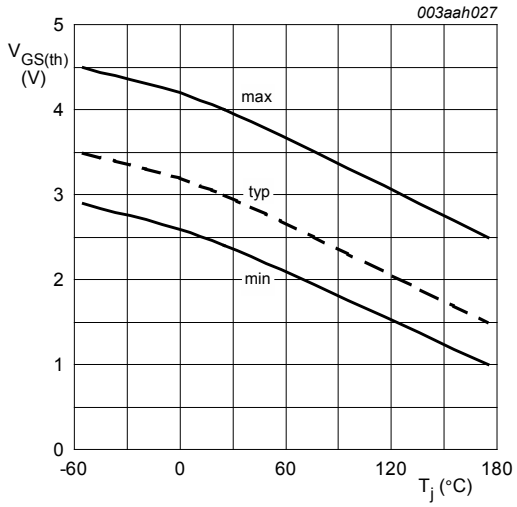



**Fig. 9. Gate-source threshold voltage as a function of junction temperature**

$I_D = 1\ mA;\ V_{DS} = V_{GS}$

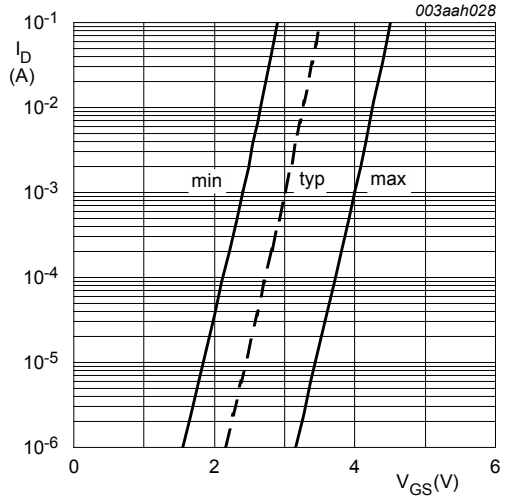
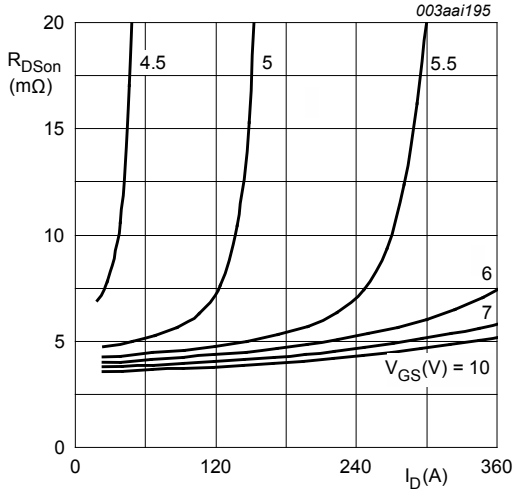



**Fig. 10. Sub-threshold drain current as a function of gate-source voltage**

$T_j = 25°C;\ V_{DS} = 5V$




$T_j$ = 25 °C; $t_p$ = 300 µs

**Fig. 11. Drain-source on-state resistance as a function of drain current; typical values**

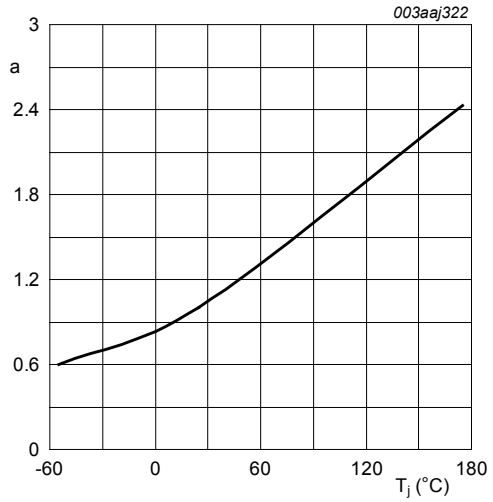
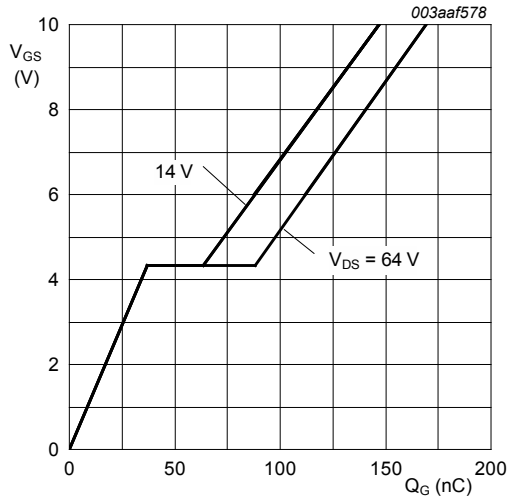



**Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature**

$$a = \frac{R_{DSon}}{R_{DSon\ (25°C)}}$$




$T_j$ = 25 °C; $I_D$ = 25 A

**Fig. 13. Gate-source voltage as a function of gate charge; typical values**

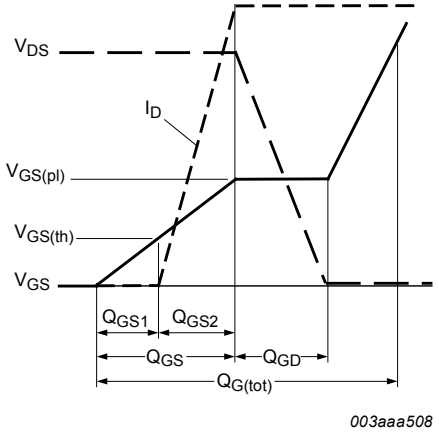
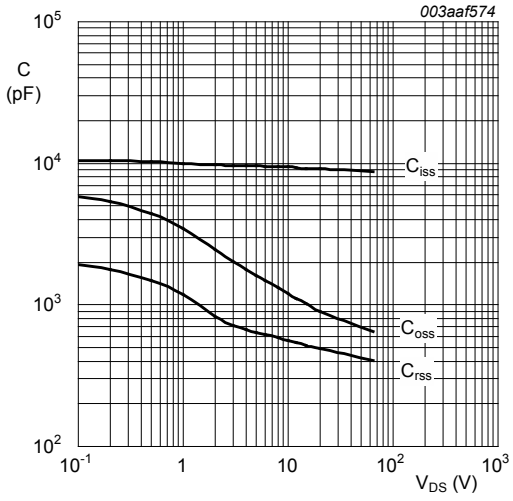
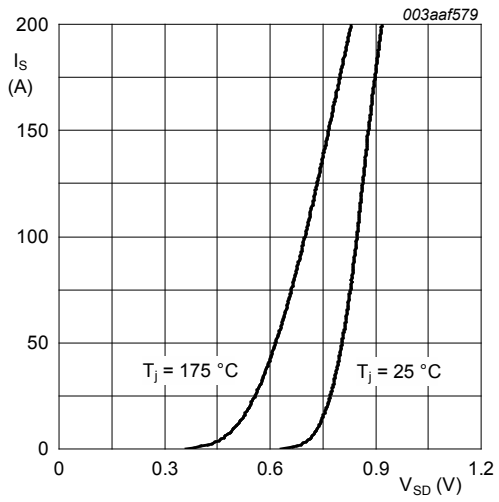



**Fig. 14. Gate charge waveform definitions**




$V_{GS}$ = 0 V; f = 1 MHz

**Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**

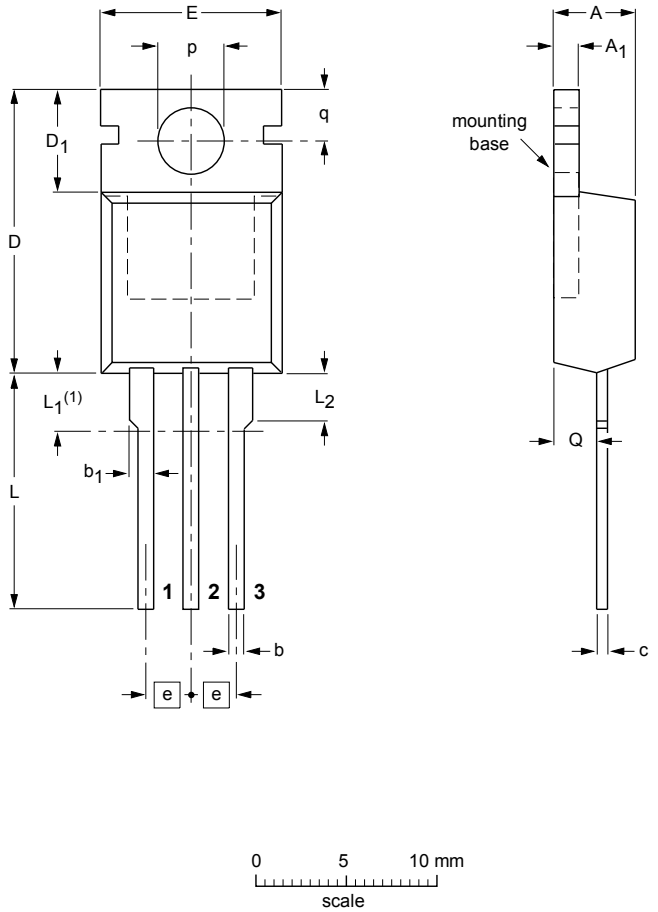



$V_{GS}$ = 0 V

**Fig. 16. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values**

# 8. Package outline

**Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB** **SOT78A**




**DIMENSIONS (mm are the original dimensions)**

| UNIT | A | $A_1$ | b | $b_1$ | c | D | $D_1$ | E | e | L | $L_1$(1) | $L_2$ max. | p | q | Q |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 4.5<br>4.1 | 1.39<br>1.27 | 0.9<br>0.6 | 1.3<br>1.0 | 0.7<br>0.4 | 15.8<br>15.2 | 6.4<br>5.9 | 10.3<br>9.7 | 2.54 | 15.0<br>13.5 | 3.30<br>2.79 | 3.0 | 3.8<br>3.6 | 3.0<br>2.7 | 2.6<br>2.2 |

**Note**

1. Terminals in this zone are not tinned.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT78A | | 3-lead TO-220AB | SC-46 | | | ~~03-01-22~~<br>05-03-14 |

**Fig. 17. Package outline TO-220AB (SOT78A)**

# 9. Legal information

## 9.1 Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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# 10. Contents





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**Date of release: 11 September 2012**